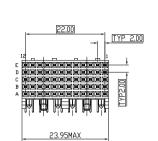
TYP 2.00

SEE NOTE 8



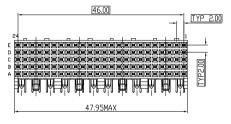
30 POSTION

REPER

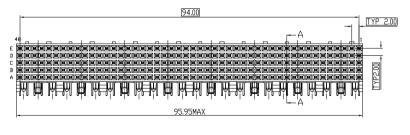
8.00

11.95MAX

60 POSTION



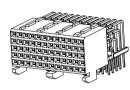
120 POSTION



240 POSTION



30 POSTION



60 POSTION

NOTE: UNLESS OTHERWISE SPECIFIED;

1. CONNECTOR MATERIALS:

HOUSING: GLASS FILLED THERMOPLASTIC,

UL94-V0 COMPLIANT

KEEPER: GLASS FILLED THERMOPLASTIC,

UL94-V0 COMPLIANT

TERMIANL: PHOSPHOR BRONZE ALLOY.

2. PACKED IN TUBES.

(3) FEATURE MAY OR MAY NOT BE PRESENT DEPENDING UPON THE MOLD TOOL USED TO PRODUCE PRODUCT.

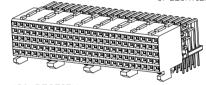
4. PRODUCT SPEIFICATION: GS-12-177.

5. APPLICATION SPECIFICATION: GS-20-015.

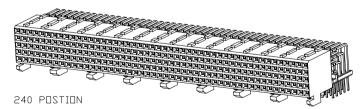
6. THE PRODUCTS WHERE THE PART NUMBER ENDS IN 'LF' MEET THE EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008.

7. ALL PRODUCTS WILL WITHSTAND EXPOSURE TO 260°C FOR 60 SECONDS IN CONVECTION, INFRA-RED OR VAPOR PHASE REFLOW OVEN.

8. LOCATION PEGS ARE ONLY EXISTED IN ONE MODULE.



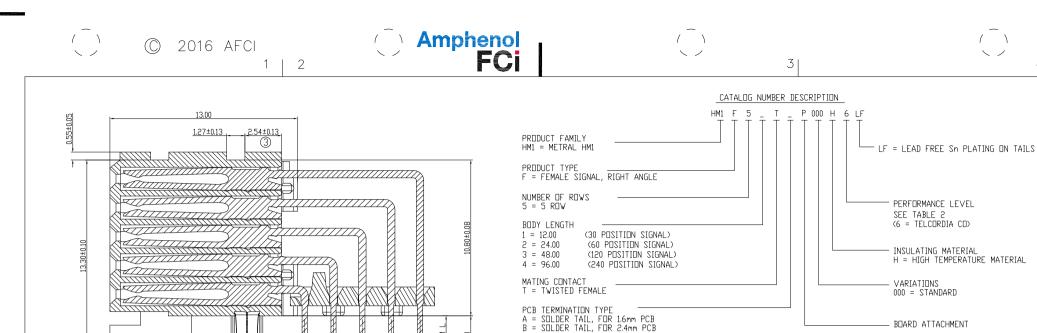
120 POSTION



ma ^r	t'l. c	ode				surface /			tolerance			projection			product family								
	ISO 1302 V			ISO 406/ISO 110 less otherwise					METRAL(tm) HPL559														
Itr	ecn no dr date						ance	s unl	ess o	other	wise	spectfied			title	;							
L	DG06-0	G06-0378 KL 09/05/06 G06-0434 Cenh 10/23/06		ana	ar		.O±	0±.3		mm		T SERIES R/A											
М	DG06-0			ung	9			.00±.13					, ,										
N	DG06-0	G06-0534 Cenh 14/12/06		0'±2' =			.000±.051			sca	le 1:	: 1	RECEPTACLE ASSY,5 RIW,STB						B				
Р	DG08-0	DG08-0173 TER 02/07/08		dr v.seb		EBAS"	BASTIAN 7/14'05		Amphenol FCi		dwg	no			S	heet	:1 (of 3	size				
R	N10-0382 Cenh 11/12/10		2/10	engr J.volst		OLSTF	TROF 7/14'05				SE96847 A4							۸.					
S	ELX-N-2	ELX-N-23029 NICK 01/13/16		3/16	chr J.VOLSTI			ROF 7/14'05										H4					
Т	EXL-N-25326 NICK 11/15/16		appd J.volst		OLSTF	TROF 7/14'05		4'05				type	9	Pro	duct	Cus	stom	er	Draw	ing			
she	et	revi	sion	Т																			
inde	index shee		et	1																			

В

form: A4mmXLc-2016-02-24



P = PRESS-FIT RETENTION PEG

BOARD ATTACHMENT

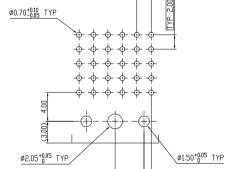


TABLE 1

9.50±0.05

5.64

	PCB THICKNESS	DIM D	DIM L	RETENTION FEATURES
HM1 F 5_ T A R 000 H6	1.60	2.90±0.30	5,20	PRESS-FIT PEGS
HM1 F 5_ T B R 000 H6	2.40	3.60±0.30	7.20	FRESS FIT FEUS
HM1 F 5_ T A P 000 H6	1.60	2.90±0.30	3.00	PRESS-FIT PEGS
HM1 F 5_ T B P 000 H6	2.40	3.60±0.30	3.00	LVE22-LII LEG2

4.00 SECTION A-A TYP 2.00

RECOMMENDED PC BOARD LAYOUT, COMPONENT SIDE SEE PRINT 58351 FOR ADDITIONAL PCB INFORMATION

4.00

1.00

CODE	CONTACT AREA	PERFORMANCE LEVEL
6	0.75um Au Min over 1.3um Ni Min or 0.68um PdNi Min + 0.08um Au Min over 1.3um Ni Min.	TELCORDIA CO

ma	t'l.	code			surface / toler				rand	ce	projection			product family									
			ISO 1302 V ISO 406/IS					0 110	1 4			METRAL(tm) HPL559											
Itr	Itr ecn no dr date						tolerances unless otherwise						fied	J	title	9							
Т						ang					mm												
						Jungles		.00±.13				DESCRIPTABLE ACCIVE DIMESTR											
						0'±2' =		.000	.000±.051			scale 1:1			RECEPTACLE ASSY,5 RIW,STB							B	
						dr	V.S	V.SEBASTIA		7/1	4'05					, no			S	heet	:2 0	of 3	size
						eng	J.V	/OLSTROF				Amphenol FCi		SF96847						A ₄			
						chr	J.V							-Ci	SE9664/						M4		
					appd J.vo		OLSTROF		7/14'05					typ	е	Pro	duct	: Cu:	stom	er [Draw	ing	
she	eet	revision		T																			
index		sheet		1																			

В

TABLE 2

form: A4mmXLc-2016-02-24

2 **PDS: Rev :T**

OBSOLETE

STATUS:Released Printed: Nov 15, 2016

